



FFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: HUEI-JEN CHEN, ETAL.

Serial No: 10/655223

Filed: SEPTEMBER 05, 2003

Patent No: 7117587

Issued: OCTOBER 10, 2006

Title: Method for fabricating a substrate,
including a plurality of chip package
substrates

:
: Art Unit
: Examiner:

REVOCATION OF POWER OF ATTORNEY AND
APPOINTMENT OF POWER OF ATTORNEY

The owner of the above-identified U. S. Patent Application,
hereby revokes all Powers of Attorney previously given and
hereby appoints the following Attorneys to transact all
business in the U. S. Patent and Trademark Office connected
therewith:

Morton J. Rosenberg, Esq., Reg. #26,049
David I. Klein, Esq., Reg. #33,253
Jun Y. Lee, Esq., Reg. #40,262
Rosenberg, Klein & Lee
3458 Ellicott Center Drive-Suite 101
Ellicott City, Maryland 21043

Send all correspondence to:

Rosenberg, Klein & Lee
3458 Ellicott Center Drive-Suite 101
Ellicott City, Maryland 21043

Please direct all telephone calls to:

(410) 465-6678

Respectfully submitted,

FOR: LITE-ON SEMICONDUCTOR CORP.

JUNE 29, 2007

Date

(SIGNATURE)

WEN-CHEN YANG (FAMILY NAME: YANG)

TITLE: MANAGER

**STATEMENT UNDER 37 CFR 3.73(b)**Applicant/Patent Owner: HUEI-JEN CHEN, ET AL.Application No./Patent No.: 7117587 Filed/Issued Dated: OCTOBER 10, 2006Entitled: Method for fabricating a substrate, including a plurality of chip package substratesLITE-ON SEMICONDUCTOR CORP., a CORPORATION

(Name of Assignee)

(Type of Assignee, e.g., corporation, partnership, university, government, agency, etc.)

states that it is:

1. ☒ the assignee of the entire right, title, and interest; or
2. ☐ an assignee of less than the entire right, title and interest.
The extent (by percentage) of its ownership interest is _____ %

In the patent application/patent identified above by virtue of either:

- A. ☒ An assignment from the inventor(s) of the patent application/patent identified above. The assignment was recorded in the United States Patent and Trademark Office at Reel 014486, Frame 0994, or for which a copy thereof is attached.

OR

- B. ☐ A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as shown below:

1. From: _____ To: _____
The document was recorded in the United States Patent and Trademark Office at Reel _____, Frame _____, or for which a copy thereof is attached.
2. From: _____ To: _____
The document was recorded in the United States Patent and Trademark Office at Reel _____, Frame _____, or for which a copy thereof is attached.
3. From: _____ To: _____
The document was recorded in the United States Patent and Trademark Office at Reel _____, Frame _____, or for which a copy thereof is attached.

☐ Additional documents in the chain of title are listed on a supplemental sheet.

- ☐ Copies of assignments or other documents in the chain of title are attached.

[NOTE: A separate copy (i.e. a true copy of the original assignment document(s)) must be submitted to Assignment Division in accordance with 37 CFR Part 3, if the assignment is to be recorded in the records of the USPTO. See MPEP 302.08]

The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.

JUNE 29, 2007

Date

LITE-ON SEMICONDUCTOR CORP.

Typed or printed name

YANG WEN-CHENSignature WEN-CHEN YANG (FAMILY NAME: YANG)MANAGER

Title

This collection of information is required by 37 CFR 3.73(b). The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application from to the USPTO. Time will vary depending upon the individual case. Any comments, on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SENT TO Commissioner for Patent, P.O. Box 1450, Alexandria, VA 22313-1450.